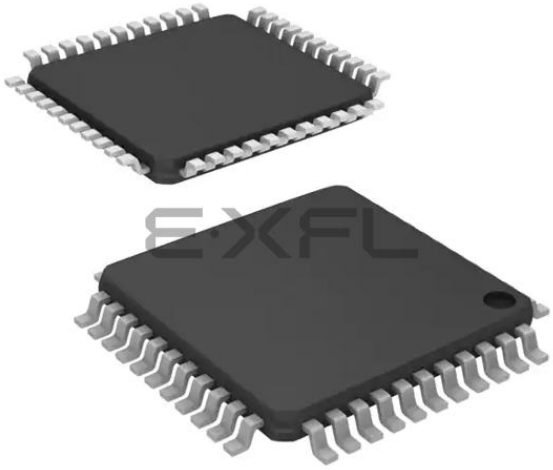
Microchip Technology - SST89E58RD2-40-I-TQJE Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	40MHz
Connectivity	EBI/EMI, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	36
Program Memory Size	40KB (40K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/sst89e58rd2-40-i-tqje

Expanded Data RAM Addressing

The SST89E/V5xRDxA both have the capability of 1K of RAM. See Figure 7.

The device has four sections of internal data memory:

1. The lower 128 Bytes of RAM (00H to 7FH) are directly and indirectly addressable.
2. The higher 128 Bytes of RAM (80H to FFH) are indirectly addressable.
3. The special function registers (80H to FFH) are directly addressable only.
4. The expanded RAM of 768 Bytes (00H to 2FFH) is indirectly addressable by the move external instruction (MOVX) and clearing the EXTRAM bit. (See “Auxiliary Register (AUXR)” in Section , “Special Function Registers”)

Since the upper 128 bytes occupy the same addresses as the SFRs, the RAM must be accessed indirectly. The RAM and SFRs space are physically separate even though they have the same addresses.

When instructions access addresses in the upper 128 bytes (above 7FH), the MCU determines whether to access the SFRs or RAM by the type of instruction given. If it is indirect, then RAM is accessed. If it is direct, then an SFR is accessed. See the examples below.

Indirect Access:

MOV@R0, #data; R0 contains 90H

Register R0 points to 90H which is located in the upper address range. Data in “#data” is written to RAM location 90H rather than port 1.

Direct Access:

MOV90H, #data; write data to P1

Data in “#data” is written to port 1. Instructions that write directly to the address write to the SFRs.

To access the expanded RAM, the EXTRAM bit must be cleared and MOVX instructions must be used. The extra 768 bytes of memory is physically located on the chip and logically occupies the first 768 bytes of external memory (addresses 000H to 2FFH).

When EXTRAM = 0, the expanded RAM is indirectly addressed using the MOVX instruction in combination with any of the registers R0, R1 of the selected bank or DPTR. Accessing the expanded RAM does not affect ports P0, P3.6 (WR#), P3.7 (RD#), or P2. With EXTRAM = 0, the expanded RAM can be accessed as in the following example.

Expanded RAM Access (Indirect Addressing only):

MOVX@DPTR, A; DPTR contains 0A0H

DPTR points to 0A0H and data in “A” is written to address 0A0H of the expanded RAM rather than external memory. Access to external memory higher than 2FFH using the MOVX instruction will access external memory (0300H to FFFFH) and will perform in the same way as the standard 8051, with P0 and P2 as data/address bus, and P3.6 and P3.7 as write and read timing signals.

When EXTRAM = 1, MOVX @Ri and MOVX @DPTR will be similar to the standard 8051. Using MOVX @Ri provides an 8-bit address with multiplexed data on Port 0. Other output port pins can be used to output higher order address bits. This provides external paging capabilities. Using MOVX

Not Recommended for New Designs

Watchdog Timer Data/Reload Register (WDTD)

Location	7	6	5	4	3	2	1	0	Reset Value
85H	Watchdog Timer Data/Reload								00H

Symbol	Function
WDTD	Initial/Reload value in Watchdog Timer. New value won't be effective until WDT is set.

PCA Timer/Counter Control Register[1] (CCON)

Location	7	6	5	4	3	2	1	0	Reset Value
D8H	CF	CR	-	CCF4	CCF3	CCF2	CCF1	CCF0	00x00000b

1. Bit addressable

Symbol	Function
CF	PCA Counter Overflow Flag Set by hardware when the counter rolls over. CF flags an interrupt if bit ECF in CMOD is set. CF may be set by either hardware or software, but can only cleared by software.
CR	PCA Counter Run control bit Set by software to turn the PCA counter on. Must be cleared by software to turn the PCA counter off.
-	Not implemented, reserved for future use. **Note:** User should not write '1's to reserved bits. The value read from a reserved bit is indeterminate.
CCF4	PCA Module 4 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.
CCF3	PCA Module 3 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.
CCF2	PCA Module 2 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.
CCF1	PCA Module 1 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.
CCF0	PCA Module 0 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.

Not Recommended for New Designs

PCA Compare/Capture Module Mode Register[1] (CCAPMn)

Location	7	6	5	4	3	2	1	0	Reset Value
DAH	-	ECOM0	CAPP0	CAPN0	MAT0	TOG0	PWM0	ECCF0	00xxx000b
DBH	-	ECOM1	CAPP1	CAPN1	MAT1	TOG1	PWM1	ECCF1	00xxx000b
DCH	-	ECOM2	CAPP2	CAPN2	MAT2	TOG2	PWM2	ECCF2	00xxx000b
DDH	-	ECOM3	CAPP3	CAPN3	MAT3	TOG3	PWM3	ECCF3	00xxx000b
DEH	-	ECOM4	CAPP4	CAPN4	MAT4	TOG4	PWM4	ECCF4	00xxx000b

1. Not bit addressable

Symbol	Function
-	Not implemented, reserved for future use. **Note:** User should not write ‘1’s to reserved bits. The value read from a reserved bit is indeterminate.
ECOMn	Enable Comparator 0: Disables the comparator function 1: Enables the comparator function
CAPPn	Capture Positive 0: Disables positive edge capture on CEX[4:0] 1: Enables positive edge capture on CEX[4:0]
CAPNn	Capture Negative 0: Disables negative edge capture on CEX[4:0] 1: Enables negative edge capture on CEX[4:0]
MATn	Match: Set ECOM[4:0] and MAT[4:0] to implement the software timer mode 0: Disables software timer mode 1: A match of the PCA counter with this module’s compare/capture register causes the CCFn bit in CCON to be set, flagging an interrupt.
TOGn	Toggle 0: Disables toggle function 1: A match of the PCA counter with this module’s compare/capture register causes the the CEXn pin to toggle.
PWMn	Pulse Width Modulation mode 0: Disables PWM mode 1: Enables CEXn pin to be used as a pulse width modulated output
ECCFn	Enable CCF Interrupt 0: Disables compare/capture flag CCF[4:0] in the CCON register to generate an interrupt request. 1: Enables compare/capture flag CCF[4:0] in the CCON register to generate an interrupt request.

Not Recommended for New Designs

SPI Control Register (SPCR)

Location	7	6	5	4	3	2	1	0	Reset Value
D5H	SPIE	SPE	DORD	MSTR	CPOL	CPHA	SPR1	SPR0	00H

Symbol	Function
SPIE	If both SPIE and ES are set to one, SPI interrupts are enabled.
SPE	SPI enable bit. 0: Disables SPI. 1: Enables SPI and connects SS#, MOSI, MISO, and SCK to pins P1.4, P1.5, P1.6, P1.7.
DORD	Data Transmission Order. 0: MSB first in data transmission. 1: LSB first in data transmission.
MSTR	Master/Slave select. 0: Selects Slave mode. 1: Selects Master mode.
CPOL	Clock Polarity 0: SCK is low when idle (Active High). 1: SCK is high when idle (Active Low).
CPHA	Clock Phase control bit. The CPHA bit with the CPOL bit control the clock and data relationship between master and slave. See Figures 21 and 22. 0: Shift triggered on the leading edge of the clock. 1: Shift triggered on the trailing edge of the clock.
SPR1, SPR0	SPI Clock Rate Select bits. These two bits control the SCK rate of the device configured as master. SPR1 and SPR0 have no effect on the slave. The relationship between SCK and the oscillator frequency, f_{OSC}, is as follows:

SPR1	SPR0	SCK = f_{OSC} divided by
0	0	4
0	1	16
1	0	64
1	1	128

SPI Status Register (SPSR)

Location	7	6	5	4	3	2	1	0	Reset Value
AAH	SPIF	WCOL	-	-	-	-	-	-	00xxxxxxb

Symbol	Function
SPIF	SPI Interrupt Flag. Upon completion of data transfer, this bit is set to 1. If SPIE =1 and ES =1, an interrupt is then generated. This bit is cleared by software.
WCOL	Write Collision Flag. Set if the SPI data register is written to during data transfer. This bit is cleared by software.

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SPI Data Register (SPDR)

Location	7	6	5	4	3	2	1	0	Reset Value
86H	SPDR[7:0]								00H

Power Control Register (PCON)

Location	7	6	5	4	3	2	1	0	Reset Value
87H	SMOD1	SMOD0	BOF	POF	GF1	GF0	PD	IDL	00010000b

Symbol	Function
SMOD1	Double Baud rate bit. If SMOD1 = 1, Timer 1 is used to generate the baud rate, and the serial port is used in modes 1, 2, and 3.
SMOD0	FE/SM0 Selection bit. 0: SCON[7] = SM0 1: SCON[7] = FE,
BOF	Brown-out detection status bit, this bit will not be affected by any other reset. BOF should be cleared by software. Power-on reset will also clear the BOF bit. 0: No brown-out. 1: Brown-out occurred
POF	Power-on reset status bit, this bit will not be affected by any other reset. POF should be cleared by software. 0: No Power-on reset. 1: Power-on reset occurred
GF1	General-purpose flag bit.
GF0	General-purpose flag bit.
PD	Power-down bit, this bit is cleared by hardware after exiting from power-down mode. 0: Power-down mode is not activated. 1: Activates Power-down mode.
IDL	Idle mode bit, this bit is cleared by hardware after exiting from idle mode. 0: Idle mode is not activated. 1: Activates idle mode.

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Timer/Counter 2 Control Register (T2CON)

Location	7	6	5	4	3	2	1	0	Reset Value
C8H	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2#	CP/RL2#	00H

Symbol	Function
TF2	Timer 2 overflow flag set by a Timer 2 overflow and must be cleared by software. TF2 will not be set when either RCLK or TCLK = 1.
EXF2	Timer 2 external flag set when either a capture or reload is caused by a negative transition on T2EX and EXEN2 = 1. When Timer 2 interrupt is enabled, EXF2 = 1 will cause the CPU to vector to the Timer 2 interrupt routine. EXF2 must be cleared by software. EXF2 does not cause an interrupt in up/down counter mode (DCEN = 1).
RCLK	Receive clock flag. When set, causes the serial port to use Timer 2 overflow pulses for its receive clock in modes 1 and 3. RCLK = 0 causes Timer 1 overflow to be used for the receive clock.
TCLK	Transmit clock flag. When set, causes the serial port to use Timer 2 overflow pulses for its transmit clock in modes 1 and 3. TCLK = 0 causes Timer 1 overflow to be used for the transmit clock.
EXEN2	Timer 2 external enable flag. When set, allows a capture or reload to occur as a result of a negative transition on T2EX if Timer 2 is not being used to clock the serial port. EXEN2 = 0 causes Timer 2 to ignore events at T2EX.
TR2	Start/stop control for Timer 2. A logic 1 starts the timer.
C/T2#	Timer or counter select (Timer 2) 0: Internal timer (OSC/6 in 6 clock mode, OSC/12 in 12 clock mode) 1: External event counter (falling edge triggered)
CP/RL2#	Capture/Reload flag. When set, captures will occur on negative transitions at T2EX if EXEN2 = 1. When cleared, auto-reloads will occur either with Timer 2 overflows or negative transitions at T2EX when EXEN2 = 1. When either RCLK = 1 or TCLK = 1, this bit is ignored and the timer is forced to auto-reload on Timer 2 overflow.

Timer/Counter 2 Mode Control (T2MOD)

Location	7	6	5	4	3	2	1	0	Reset Value
C9H	X	-	-	-	-	-	T2OE	DCEN	xxxxxx00b

Symbol	Function
X	Don't Care
-	Not implemented, reserved for future use. **Note:** User should not write '1's to reserved bits. The value read from a reserved bit is indeterminate.
T2OE	Timer 2 Output Enable bit.
DCEN	Down Count Enable bit. When set, this allows Timer 2 to be configured as an up/down counter.

Not Recommended for New Designs

Block-Erase

The Block-Erase command erases all bytes in one of the two memory blocks (Block 0 or Block 1). The selection of the memory block to be erased is determined by the (SFAH[7]) of the SuperFlash Address Register. For SST89E5xRD2A/RDA, if SFAH[7] = 0b, the primary flash memory Block 0 is selected. If SFAH[7:4] = EH, the secondary flash memory Block 1 is selected. The Block-Erase command sequence for SST89E5xRD2A/RDA is as follows:

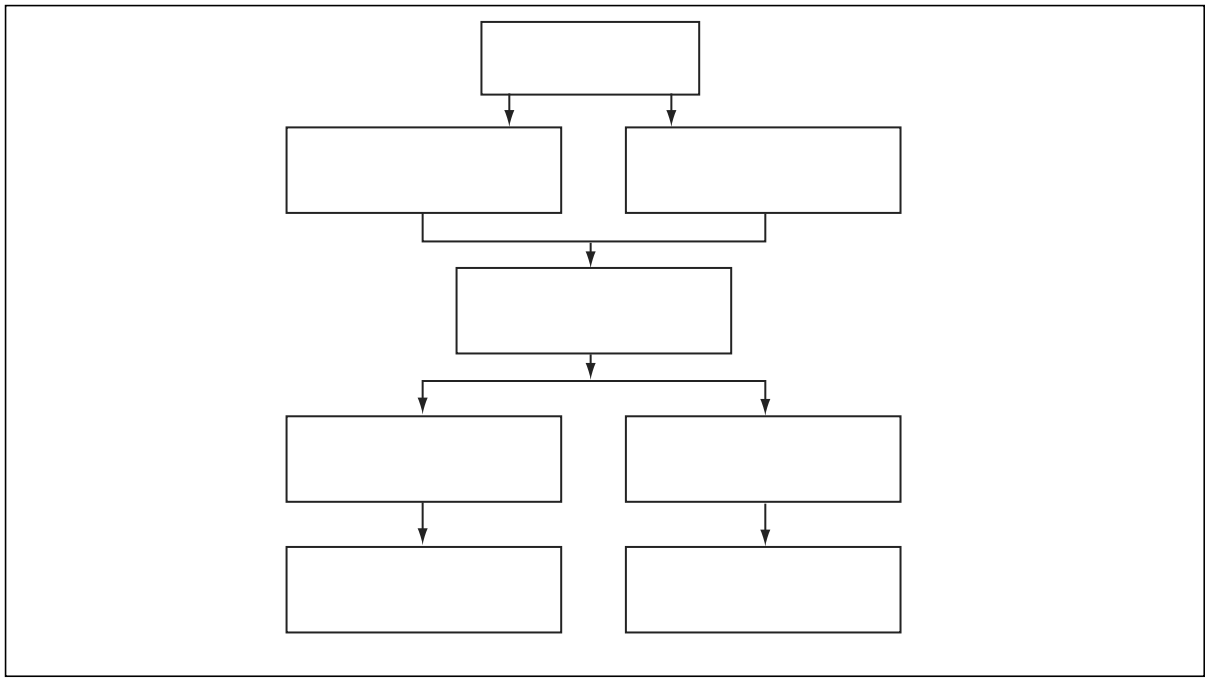

Figure 10: Block-Erase

Not Recommended for New Designs

Sector-Erase

The Sector-Erase command erases all of the bytes in a sector. The sector size for the flash memory blocks is 128 Bytes. The selection of the sector to be erased is determined by the contents of SFAH and SFAL.

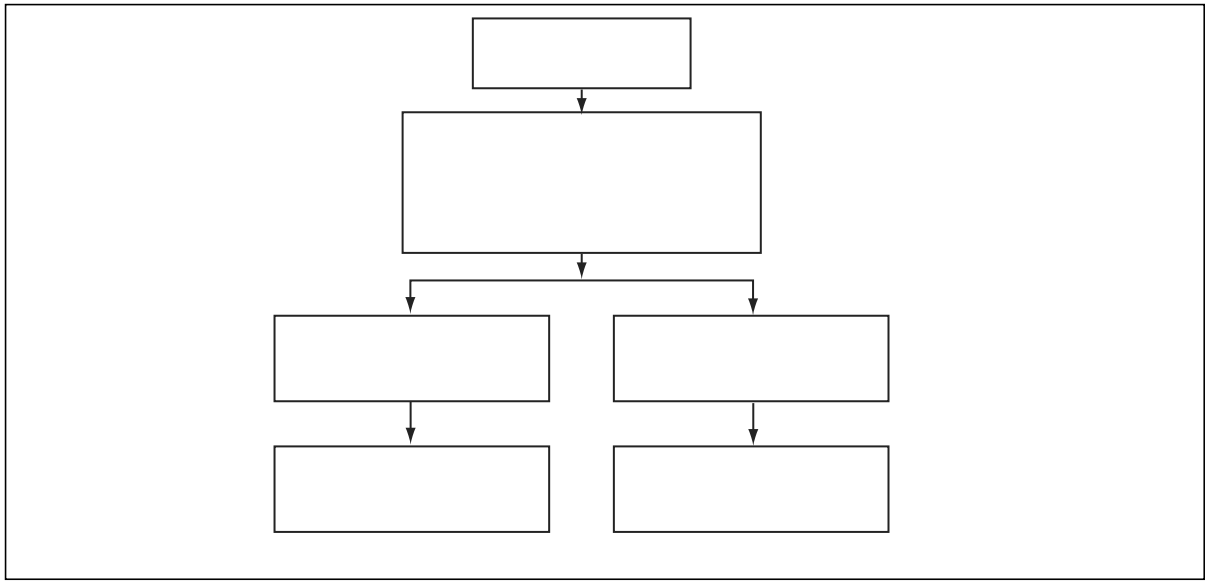

Figure 11: Sector-Erase

Not Recommended for New Designs

Byte-Verify

The Byte-Verify command allows the user to verify that the device has correctly performed an Erase or Program command. Byte-Verify command returns the data byte in SFDT if the command is successful. The user is required to check that the previous flash operation has fully completed before issuing a Byte-Verify. Byte-Verify command execution time is short enough that there is no need to poll for command completion and no interrupt is generated.

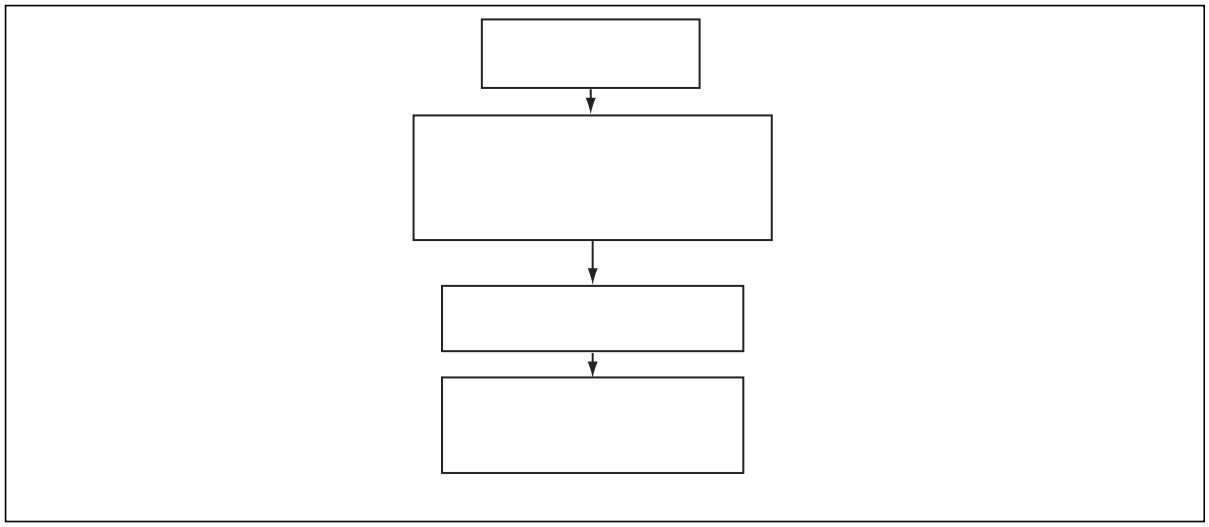

Figure 13: Byte-Verify

Prog-SB3, Prog-SB2, Prog-SB1

Prog-SB3, Prog-SB2, Prog-SB1 commands are used to program the security bits (see Table 24). Completion of any of these commands, the security options will be updated immediately.

Security bits previously in un-programmed state can be programmed by these commands. Prog-SB3, Prog-SB2 and Prog-SB1 commands should only reside in Block 1 or external code memory.

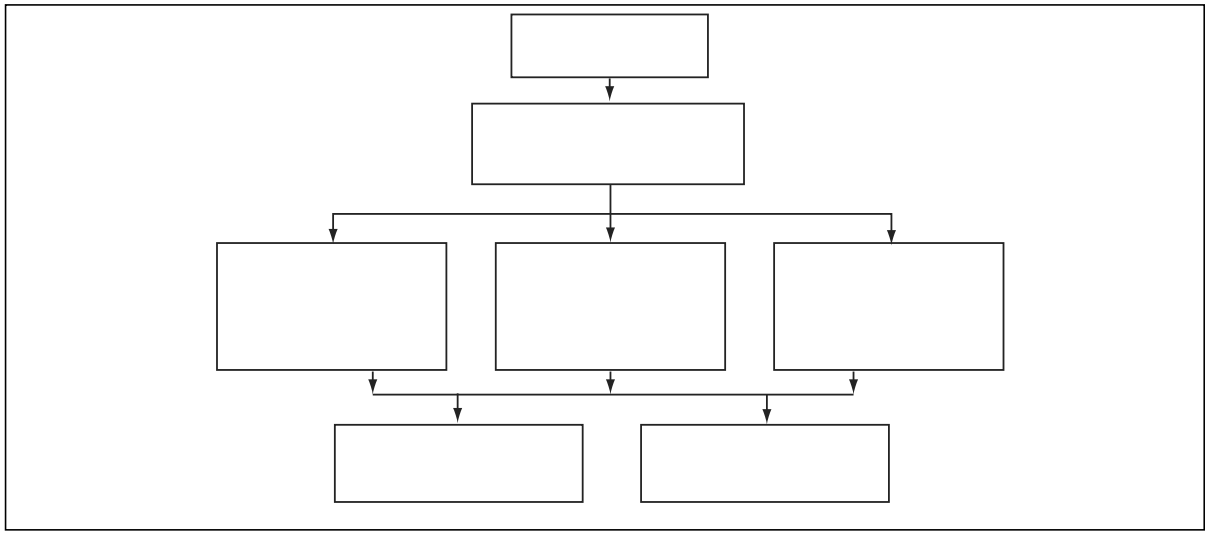

Figure 14: Prog-SB3, Prog-SB2, Prog-SB1

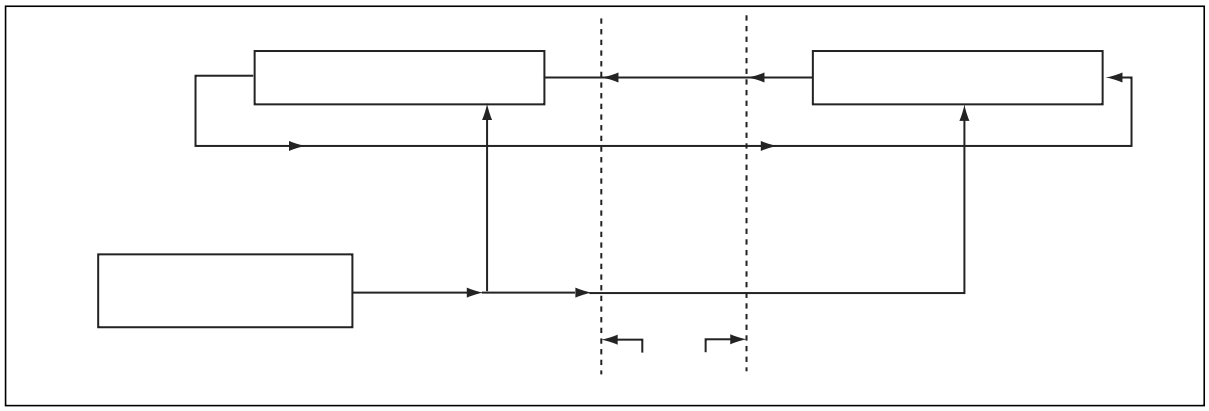

Figure 20: SPI Master-slave Interconnection

SPI Transfer Formats

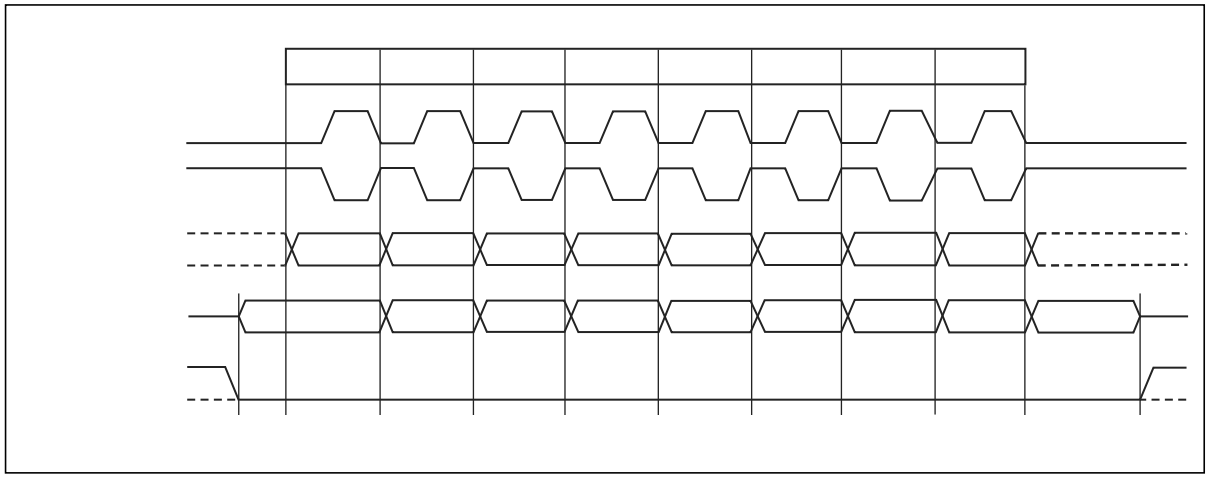

Figure 21: SPI Transfer Format with CPHA = 0

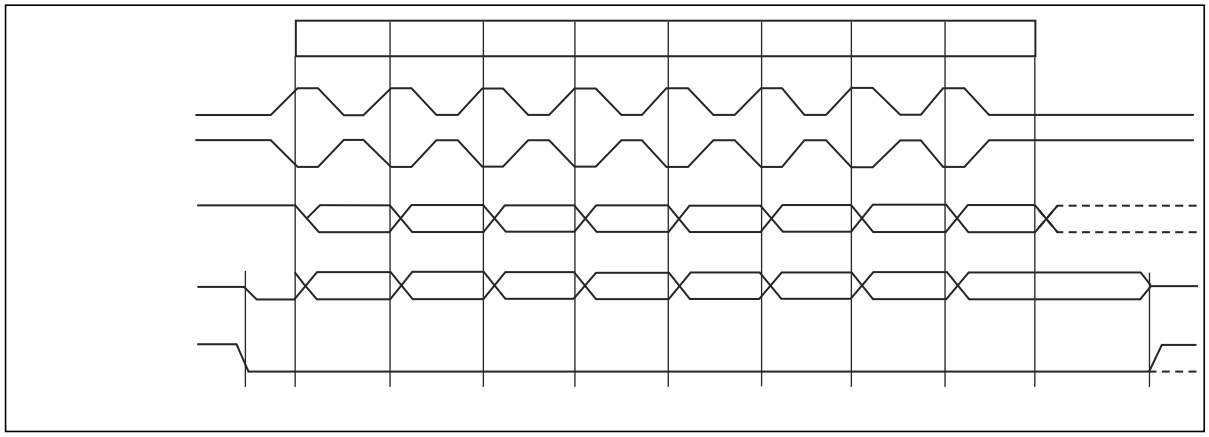

Figure 22: SPI Transfer Format with CPHA = 1

Watchdog Timer

The device offers a programmable Watchdog Timer (WDT) for fail safe protection against software deadlock and automatic recovery.

To protect the system against software deadlock, the user software must refresh the WDT within a user-defined time period. If the software fails to do this periodical refresh, an internal hardware reset will be initiated if enabled (WDRE= 1). The software can be designed such that the WDT times out if the program does not work properly.

The WDT in the device uses the system clock (XTAL1) as its time base. So strictly speaking, it is a watchdog counter rather than a watchdog timer. The WDT register will increment every 344,064 crystal clocks. The upper 8-bits of the time base register (WDTD) are used as the reload register of the WDT.

The WDTS flag bit is set by WDT overflow and is not changed by WDT reset. User software can clear WDTS by writing “1” to it.

Figure 23 provides a block diagram of the WDT. Two SFRs (WDTC and WDTD) control watchdog timer operation. During idle mode, WDT operation is temporarily suspended, and resumes upon an interrupt exit from idle.

The time-out period of the WDT is calculated as follows:

Period = (255 - WDTD) * 344064 * $1/f_{CLK\ (XTAL1)}$

where WDTD is the value loaded into the WDTD register and f_{OSC} is the oscillator frequency.

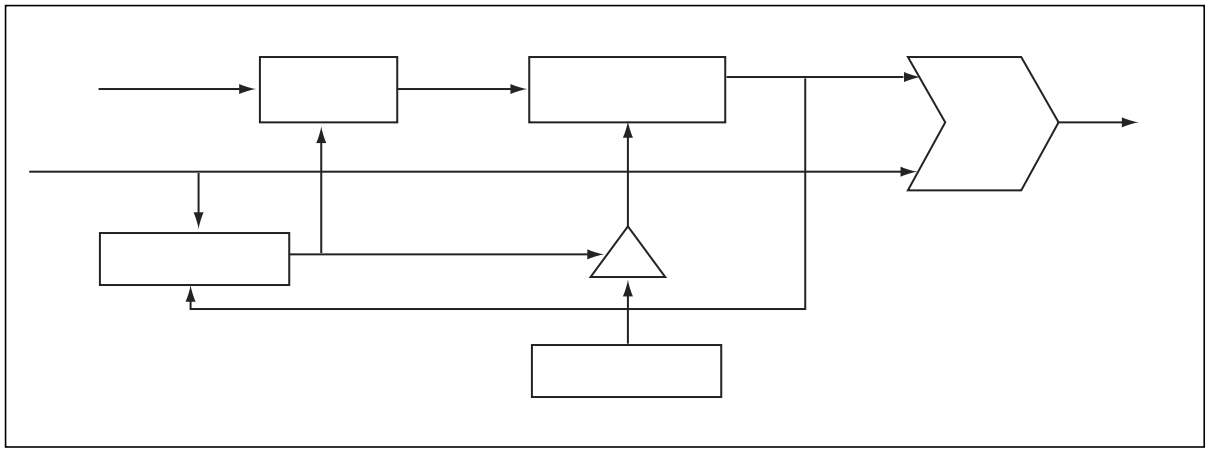

Figure 23: Block Diagram of Programmable Watchdog Timer

Not Recommended for New Designs

Capture Mode

Capture mode is used to capture the PCA timer/counter value into a module's capture registers (CCAPnH and CCAPnL). The capture will occur on a positive edge, negative edge, or both on the corresponding module's pin. To use one of the PCA modules in the capture mode, either one or both the CCAPM bits CAPN and CAPP for that module must be set. When a valid transition occurs on the CEX pin corresponding to the module used, the PCA hardware loads the 16-bit value of the PCA counter register (CH and CL) into the module's capture registers (CCAPnL and CCAPnH). If the CCFn bit for the module in the CCON SFR and the ECCFn bit in the CCAPMn SFR are set, then an interrupt will be generated. In the interrupt service routine, the 16-bit capture value must be saved in RAM before the next event capture occurs. If a subsequent capture occurred, the original capture values would be lost. After flag event flag has been set by hardware, the user must clear the flag in software. (See Figure 25)

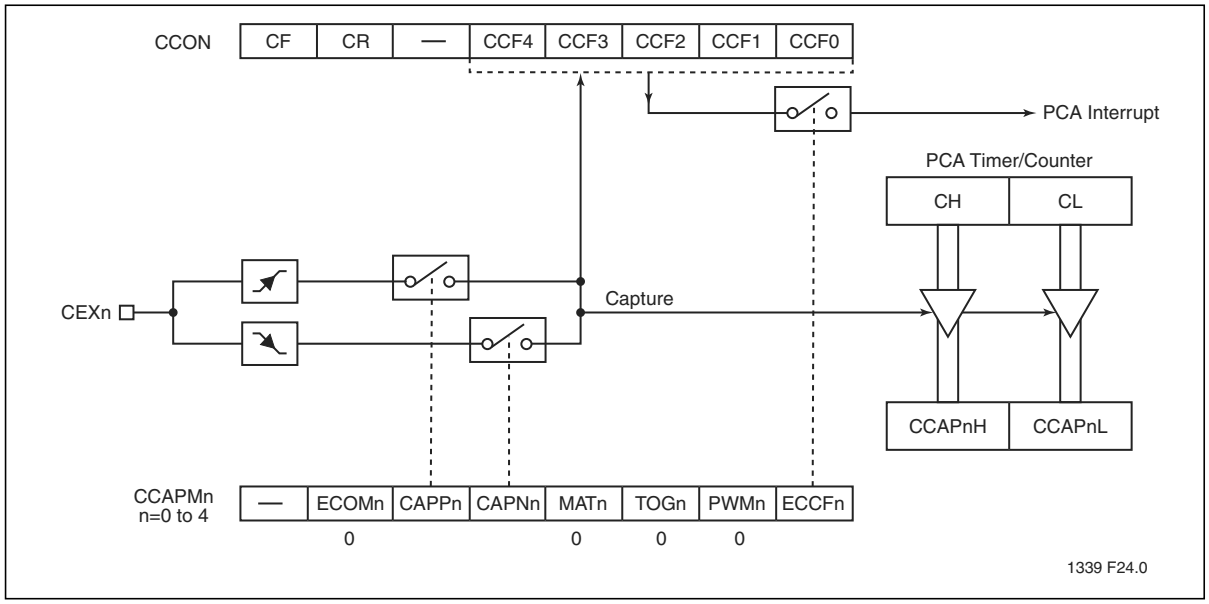

Figure 25: PCA Capture Mode

Interrupts

Interrupt Priority and Polling Sequence

The device supports eight interrupt sources under a four level priority scheme. Table 26 summarizes the polling sequence of the supported interrupts. Note that the SPI serial interface and the UART share the same interrupt vector. (See Figure 32)

Table 26: Interrupt Polling Sequence

Description	Interrupt Flag	Vector Address	Interrupt Enable	Interrupt Priority	Service Priority	Wake-Up Power-down
Ext. Int0	IE0	0003H	EX0	PX0/H	1(highest)	yes
Brown-out	-	004BH	EBO	PBO/H	2	no
T0	TF0	000BH	ET0	PT0/H	3	no
Ext. Int1	IE1	0013H	EX1	PX1/H	4	yes
T1	TF1	001BH	ET1	PT1/H	5	no
PCA	CF/CCFn	0033H	EC	PPCH	6	no
Ext. Int. 2	IE2	003BH	EX2	PX2/H	7	no
Ext. Int. 3	IE3	0043H	EX3	PX3/H	8	no
UART/SPI	TI/RI/SPIF	0023H	ES	PS/H	9	no
T2	TF2, EXF2	002BH	ET2	PT2/H	10	no

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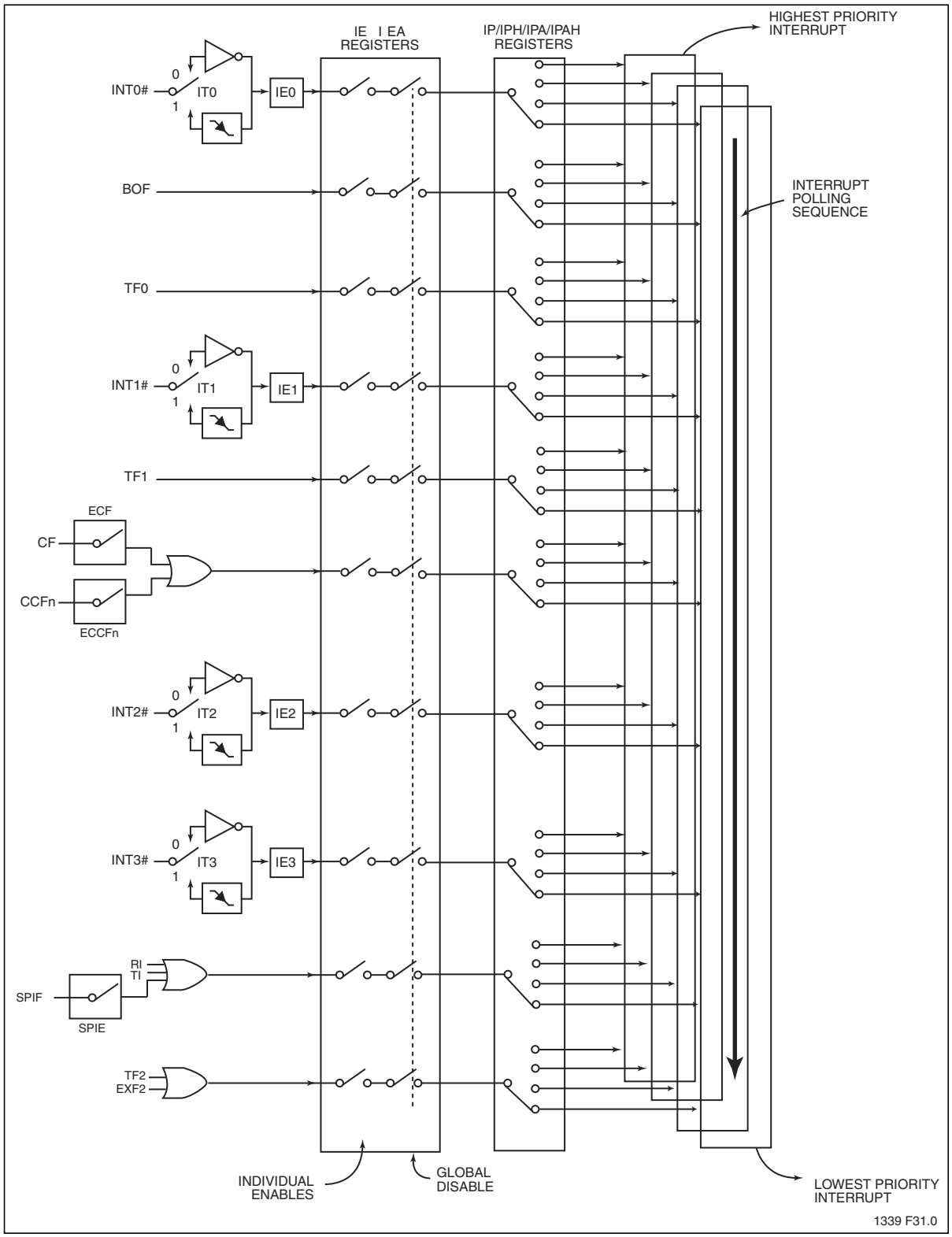

Figure 32: Interrupt Structure

Clock Doubling Option

By default, the device runs at 12 clocks per machine cycle (x1 mode). The device has a clock doubling option to speed up to 6 clocks per machine cycle. Please refer to Table 29 for detail.

Clock double mode can be enabled either via the external host mode or the IAP mode. Please refer to Table 13 for the IAP mode enabling commands (When set, the EDC# bit in SFST register will indicate 6 clock mode.).

The clock double mode is only for doubling the internal system clock and the internal flash memory, i.e. EA#=1. To access the external memory and the peripheral devices, careful consideration must be taken. Also note that the crystal output (XTAL2) will not be doubled.

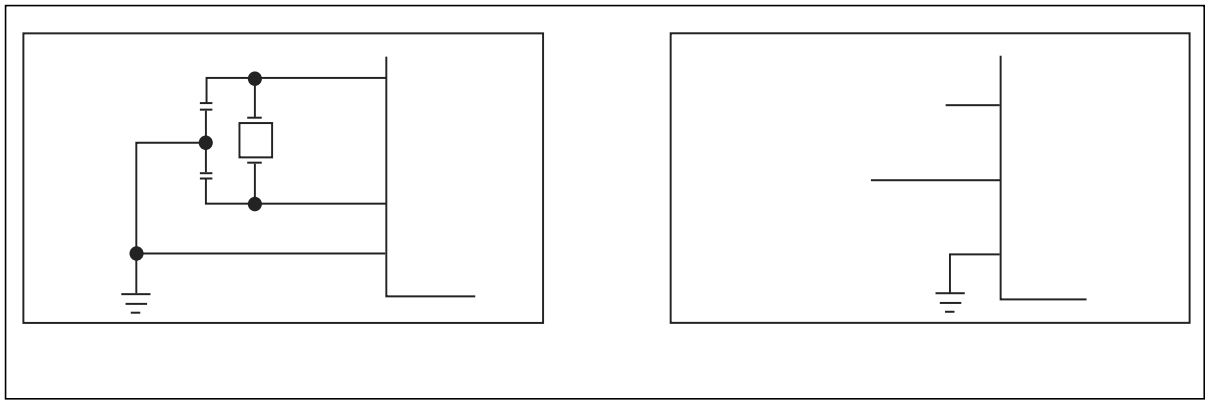

Figure 33: Oscillator Characteristics

Table 29: Clock Doubling Features

Device	Standard Mode (x1)		Clock Double Mode (x2)	
	Clocks per Machine Cycle	Max. External Clock Frequency (MHz)	Clocks per Machine Cycle	Max. External Clock Frequency (MHz)
SST89E5xRD2A/RDA	12	40	6	20

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1. Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:
   Maximum I_{OL} per port pin: 15mA
   Maximum I_{OL} per 8-bit port:26mA
   Maximum I_{OL} total for all outputs:71mA
   If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification.
   Pins are not guaranteed to sink current greater than the listed test conditions.
2. Capacitive loading on Ports 0 and 2 may cause spurious noise to be superimposed on the V_{OL}s of ALE and Ports 1 and 3. The noise due to external bus capacitance discharging into the Port 0 and 2 pins when the pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100pF), the noise pulse on the ALE pin may exceed 0.8V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input.
3. Load capacitance for Port 0, ALE and PSEN#= 100pF, load capacitance for all other outputs = 80pF.
4. Capacitive loading on Ports 0 and 2 may cause the V_{OH} on ALE and PSEN# to momentarily fall below the V_{DD} - 0.7 specification when the address bits are stabilizing.
5. Pins of Ports 1, 2, and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when V_{IN} is approximately 2V.
6. Pin capacitance is characterized but not tested. EA# is 25pF (max).

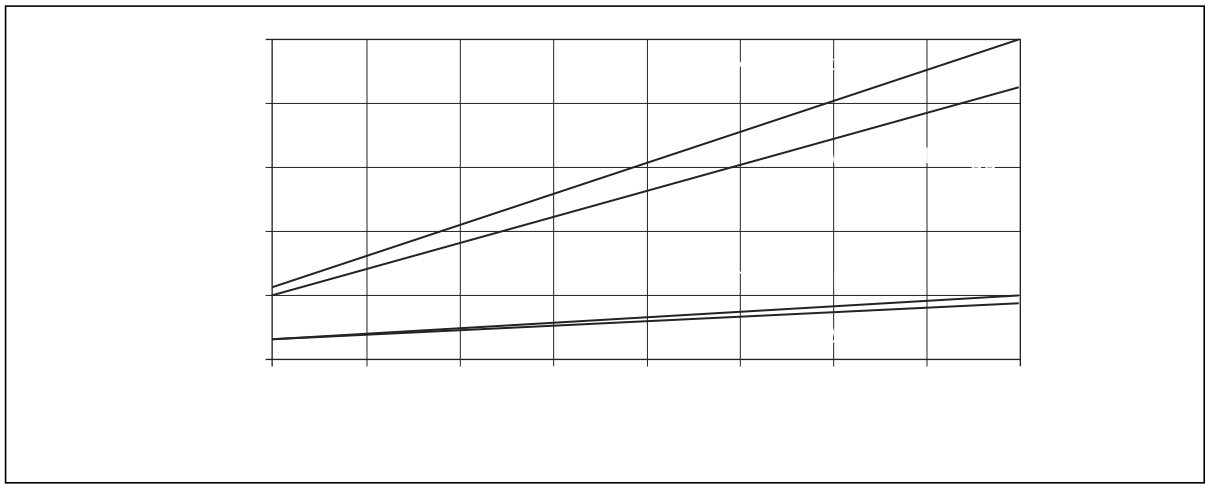

Figure 34: I_{DD} vs. Frequency for 5V SST89E5xRD2A/RDA

Not Recommended for New Designs

Table 36: AC Electrical Characteristics (Continued) (2 of 2)
T_A = -40°C to +85°C, V_{DD} = 4.5-5.5V@40MHz, V_{SS} = 0V

		Oscillator				
		40 MHz (x1 Mode) 20 MHz (x2 Mode)		Variable		
Symbol	Parameter	Min	Max	Min	Max	Units
T_{LLWL}	ALE Low to RD# or WR# Low	60	90	$3T_{CLCL}$ - 25 (3V) $3T_{CLCL}$ - 15 (5V)	$3T_{CLCL}$ + 25 (3V) $3T_{CLCL}$ + 15 (5V)	ns
T_{AVWL}	Address to RD# or WR# Low			$4T_{CLCL}$ - 75 (3V)		ns
		70		$4T_{CLCL}$ - 30 (5V)		ns
T_{WHQX}	Data Hold After WR#			T_{CLCL} - 27 (3V)		ns
		5		T_{CLCL} - 20 (5V)		ns
T_{QVWH}	Data Valid to WR# High			$7T_{CLCL}$ - 70 (3V)		ns
		125		$7T_{CLCL}$ - 50 (5V)		ns
T_{QVWX}	Data Valid to WR# High to Low Transition	5		T_{CLCL} - 20		ns
T_{RLAZ}	RD# Low to Address Float		0		0	ns
T_{WHLH}	RD# to WR# High to ALE High			T_{CLCL} - 25 (3V)	T_{CLCL} + 25 (3V)	ns
		10	40	T_{CLCL} - 15 (5V)	T_{CLCL} + 15 (5V)	ns

T0-0.0 25114

Explanation of Symbols

Each timing symbol has 5 characters. The first character is always a 'T' (stands for time). The other characters, depending on their positions, stand for the name of a signal or the logical status of that signal. The following is a list of all the characters and what they stand for.

A: Address
C: Clock
D: Input data
H: Logic level HIGH
I: Instruction (program memory contents)
L: Logic level LOW or ALE
P: PSEN#
Q: Output data
R: RD# signal
T: Time
V: Valid
W: WR# signal
X: No longer a valid logic level
Z: High Impedance (Float)

For example:

T_{AVLL} = Time from Address Valid to ALE Low

T_{LLPL} = Time from ALE Low to PSEN# Low

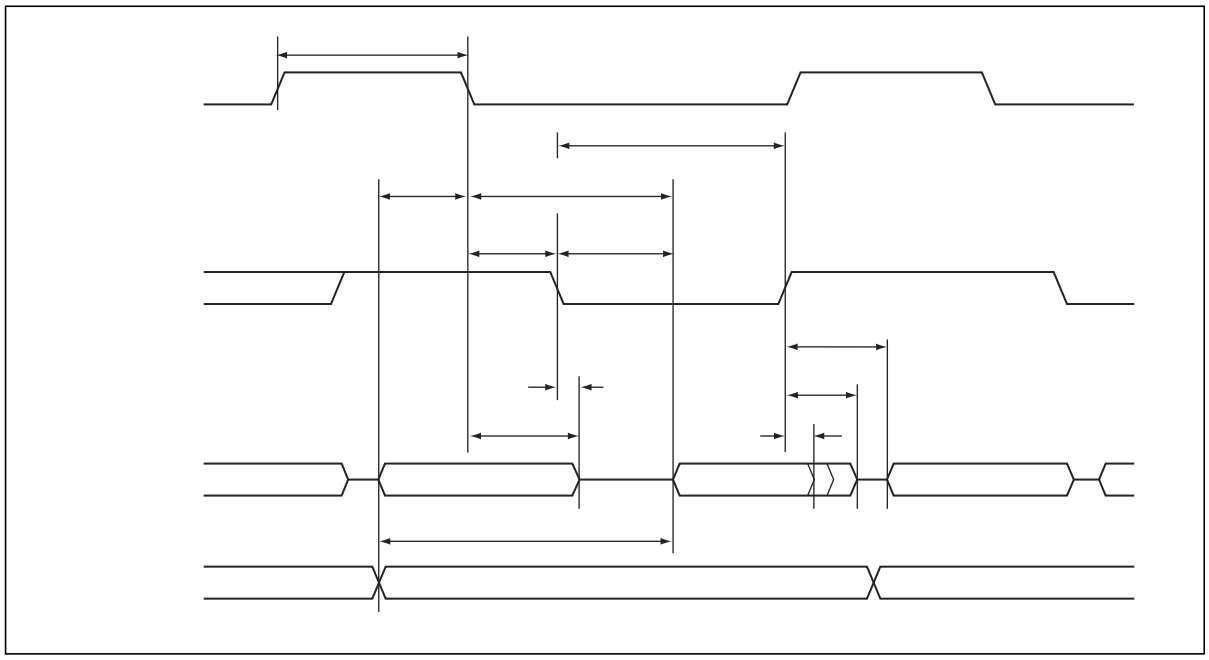

Figure 35: External Program Memory Read Cycle

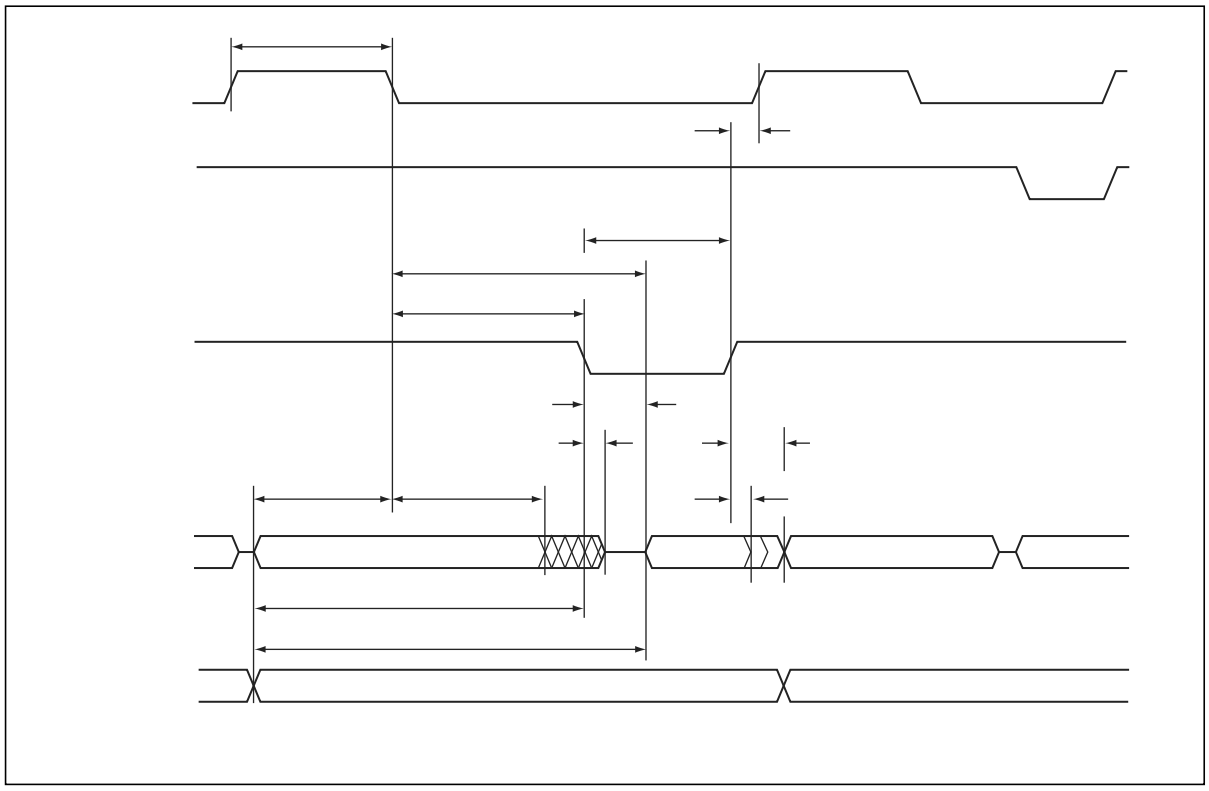

Figure 36: External Data Memory Read Cycle

Not Recommended for New Designs

Valid Combinations

Valid combinations for SST89E54RD2A

SST89E54RD2A-40-C-NJE SST89E54RD2A-40-C-TQJE

Valid combinations for SST89E58RD2A

SST89E58RD2A-40-C-NJE SST89E58RD2A-40-C-TQJE

Valid combinations for SST89E54RDA

SST89E54RDA-40-C-PIE

Valid combinations for SST89E58RDA

SST89E58RDA-40-C-PIE

Note: Valid combinations are those products in mass production or will be in mass production. Consult your SST sales representative to confirm availability of valid combinations and to determine availability of new combinations.